# 2SC2776

## Silicon NPN Epitaxial Planar

# **HITACHI**

### **Application**

- VHF amplifier
- Mixer, Local oscillator

#### **Outline**





## 2SC2776

### **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	$V_{CEO}$	20	V
Emitter to base voltage	$V_{EBO}$	4	V
Collector current	I <sub>c</sub>	30	mA
Collector power dissipation	P <sub>c</sub>	100	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

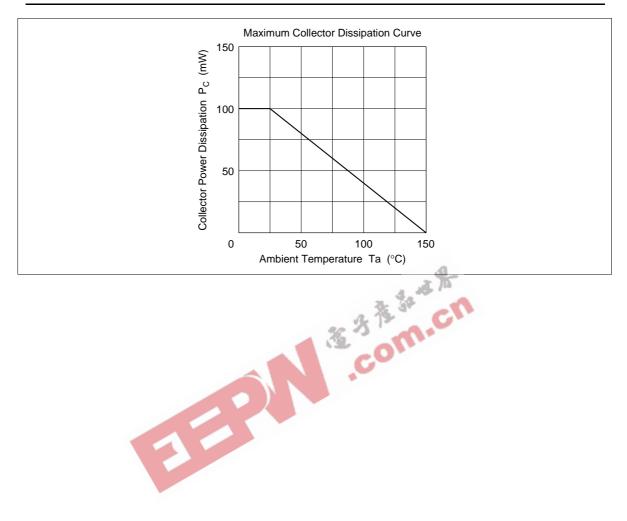
<b>Electrical Characteristics</b> (Ta = 25°C)			a to the			
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	- 3	25	V	$I_{c} = 10 \mu A, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	20		·C.	V	$I_{\rm C}$ = 1 mA, $R_{\rm BE}$ = $\infty$
Emitter to base breakdown voltage	V <sub>(BR)EBO</sub>	4		_	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	0.5	μΑ	$V_{CB} = 10 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	35	_	200		$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	_	0.8	1.2	V	$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA
Collector output capacitance	Cob	_	1.1	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f <sub>T</sub>	_	320	_	MHz	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Noise figure	NF	_	5.5	_	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ $f = 100 \text{ MHz}, R_{g} = 50 \Omega$
Power gain	PG	_	17	_	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ $f = 100 \text{ MHz}, R_g = 100 \Omega,$ $R_L = 550 \Omega, \text{ Unneutralized}$

Note: 1. The 2SC2776 is grouped by  $h_{\text{FE}}$  as follows.

Grade	Α	В	С
Mark	VA	VB	VC
h <sub>FE</sub>	35 to 70	60 to 120	100 to 200

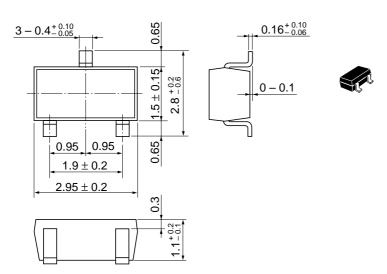
See characteristic curves of 2SC1342.

## 2SC2776





Unit: mm



Hitachi Code	MPAK
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.011 a

#### **Cautions**

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Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109 URI

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#### For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group.

Whitebrook Park

Lower Cookham Road

Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd

Taipei Branch Office 3F, Hung Kuo Building. No.167 Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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